300mA, Thermal Folded Back CMOS LDO Regulator

General Description

The RT9198T is designed for portable RF and wireless applications with demanding performance and space requirements. The RT9198T performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The RT9198T also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The RT9198T consumes less than 0.01uA in shutdown mode and has fast turn-on time less than 50μs. RT9198T is short circuit thermal folded back protected. RT9198T lowers its OTP trip point from 165°C to 110°C when output short circuit occurs (V_{OUT} < 0.4V) providing maximum safety to end users. The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio. Available in the SOT-23-3, SOT-23-5 and SC-70-5 packages, the RT9198T also offers a range of 1.5V to 3.5V with 0.1V per step.

Ordering Information

RT9198T-□□□□

Package Type
U5 : SC-70-5
U5R : SC-70-5 (R-Type)
V : SOT-23-3
B : SOT- 23-5
BR : SOT- 23-5 (R-Type)

Lead Plating System
P : Pb Free
G : Green (Halogen Free and Pb Free)

Output Voltage
15 : 1.5V
16 : 1.6V
:
34 : 3.4V
35 : 3.5V
1H : 1.85V
2H : 2.85V

Note :

Richtek products are :

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- Suitable for use in SnPb or Pb-free soldering processes.

Features

- **Short Circuit Thermal Folded Back Protection**
- **Low-Noise for RF Application**
- **Fast Response in Line/Load Transient**
- **Quick Start-Up (Typically 50us)**
- **< 0.01uA Standby Current When Shutdown**
- **Low Dropout : 220mV @ 300mA**
- **Wide Operating Voltage Ranges : 2.5V to 5.5V**
- **TTL-Logic-Controlled Shutdown Input**
- **Low Temperature Coefficient**
- **Current Limiting Protection**
- **Thermal Shutdown Protection**
- **Only 1uF Output Capacitor Required for Stability**
- **High Power Supply Rejection Ratio**
- **Custom Voltage Available**
- **RoHS Compliant and 100% Lead (Pb)-Free**

Applications

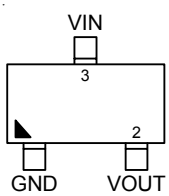
- CDMA/GSM Cellular Handsets
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers
- Hand-Held Instruments
- PCMCIA Cards
- Portable Information Appliances

Marking Information

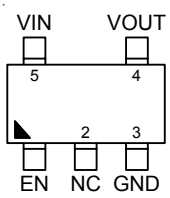
For marking information, contact our sales representative directly or through a Richtek distributor located in your area.

Pin Configurations

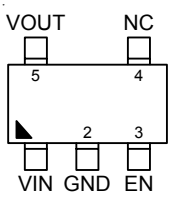
(TOP VIEW)



SOT-23-3

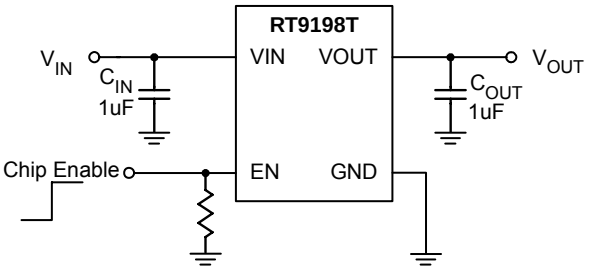


SOT-23-5/SC-70-5



SOT-23-5/SC-70-5 (R-Type)

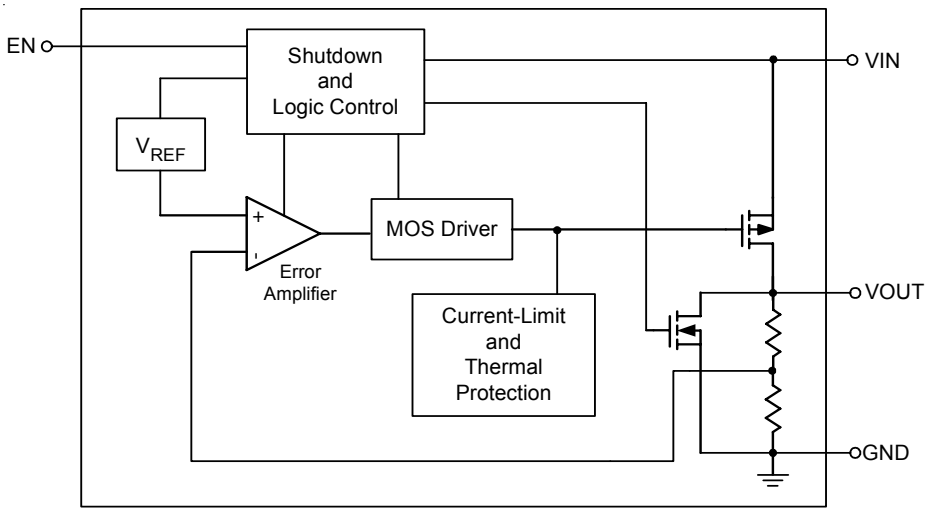
Typical Application Circuit



Functional Pin Description

Pin Name	Pin Function
EN	Chip Enable (Active High). Note that this pin is high impedance. There should be a pull low 100kΩ resistor connected to GND when the control signal is floating.
NC	No Connection
GND	Ground
VOUT	Output Voltage
VIN	Input Voltage

Function Block Diagram



Absolute Maximum Ratings (Note 1)

- Supply Input Voltage ---------- 6V
- Power Dissipation, P_D @ T_A = 25°C
  - SOT-23-3 ---------- 0.4W
  - SOT-23-5 ---------- 0.4W
  - SC-70-5 ---------- 0.3W
- Package Thermal Resistance (Note 2)
  - SOT-23-3, θ_{JA} ---------- 250°C/W
  - SOT-23-5, θ_{JA} ---------- 250°C/W
  - SC-70-5, θ_{JA} ---------- 333°C/W
- Junction Temperature ---------- 150°C
- Lead Temperature (Soldering, 10 sec.) ---------- 260°C
- Storage Temperature Range ---------- –65°C to 150°C
- ESD Susceptibility (Note 3)
  - HBM (Human Body Mode) ---------- 2kV
  - MM (Machine Mode) ---------- 200V

Recommended Operating Conditions (Note 4)

- Supply Input Voltage ---------- 2.5V to 5.5V
- Operation Ambient Temperature Range ---------- –40°C to 85°C
- Operation Junction Temperature Range ---------- –40°C to 125°C

Electrical Characteristics

(V_{IN} = V_{OUT} + 1V, C_{IN} = C_{OUT} = 1uF, T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage Accuracy		ΔV_{OUT}	I_{OUT} = 1mA	–2	--	+2	%
Current Limit		I_{LIM}	R_{LOAD} = 1Ω	360	400	--	mA
Quiescent Current		I_Q	V_{EN} >= 1.2V, I_{OUT} = 0mA	--	90	130	uA
Dropout Voltage (Note 5)		V_{DROP}	I_{OUT} = 200mA	--	170	200	mV
			I_{OUT} = 300mA	--	220	330	
Line Regulation		ΔV_{LINE}	V_{IN} = (V_{OUT} + 1V) to 5.5V, I_{OUT} = 1mA	--	--	0.3	%
Load Regulation		ΔV_{LOAD}	1mA < I_{OUT} < 300mA	--	--	0.6	%
Standby Current		I_{STBY}	V_{EN} = GND, Shutdown	--	0.01	1	uA
EN Input Bias Current		I_{IBSD}	V_{EN} = GND or VIN	--	0	100	nA
EN Threshold	Logic-Low Voltage	V_{IL}	V_{IN} = 3V to 5.5V, Shutdown	--	--	0.4	V
	Logic-High Voltage	V_{IH}	V_{IN} = 3V to 5.5V, Start-Up	1.2	--	--	
Power Supply Rejection Rate	f = 100Hz	PSRR	C_{OUT} = 1uF, I_{OUT} = 100mA	--	–60	--	dB
	f = 10kHz			--	–30	--	
Thermal Shutdown Temperature		T_{SD}		--	165	--	°C
Thermal Shutdown Temperature Hysteresis		ΔT_{SD}		--	30	--	°C
Thermal Folded Back				--	110	--	°C

Note 1. Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

Note 2. θ_{JA} is measured in the natural convection at T_A = 25°C on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

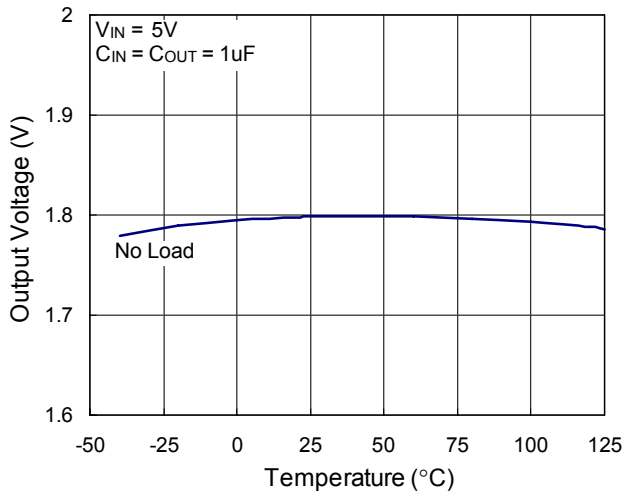
Note 3. Devices are ESD sensitive. Handling precaution is recommended.

Note 4. The device is not guaranteed to function outside its operating conditions.

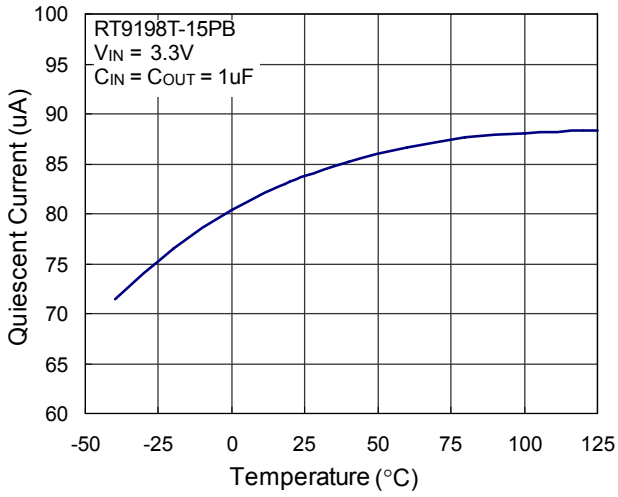
Note 5. The dropout voltage is defined as V_{IN} -V_{OUT}, which is measured when V_{OUT} is $V_{OUT(NORMAL)}$ – 100mV.

Typical Operating Characteristics

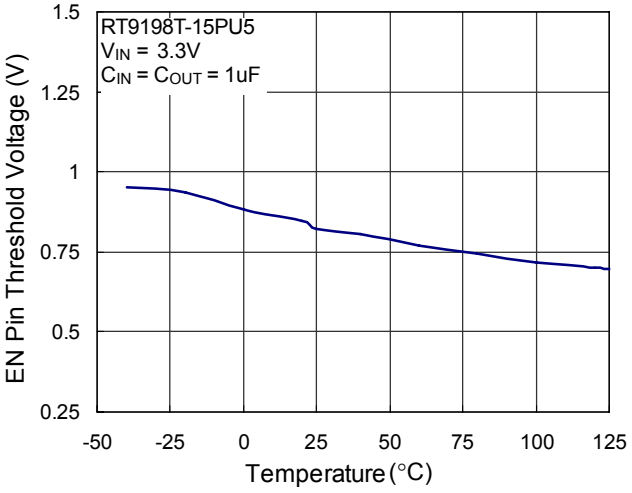
Output Voltage vs. Temperature



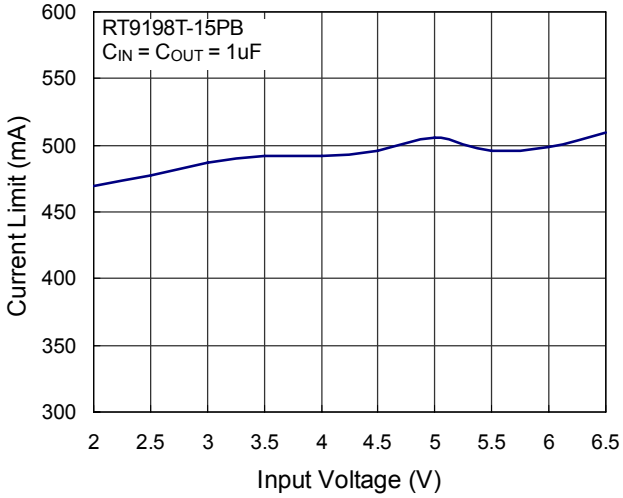
Quiesent Current vs. Temperature



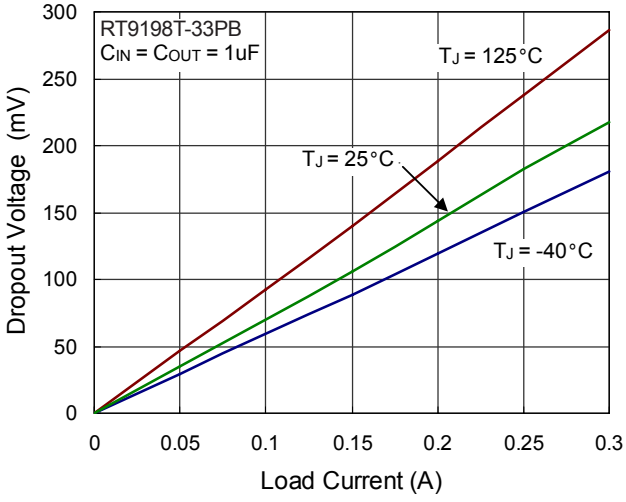
EN Pin Shutdown Threshold vs. Temperature



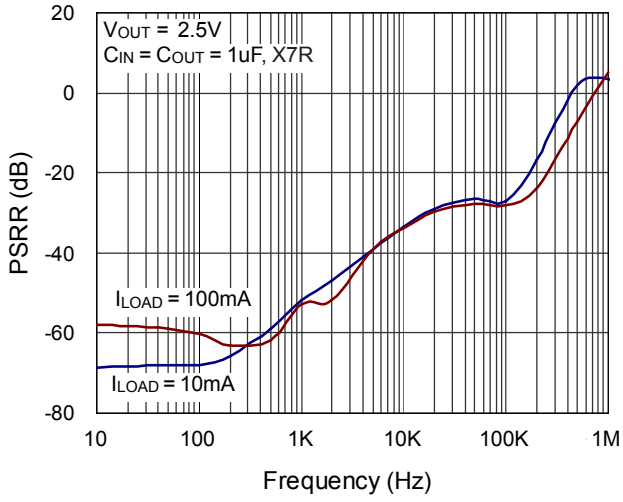
Current Limit vs. Input Voltage



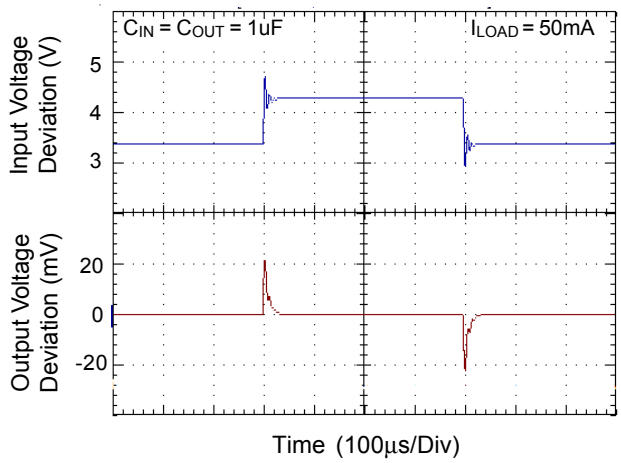
Dropout Voltage vs. Load Current



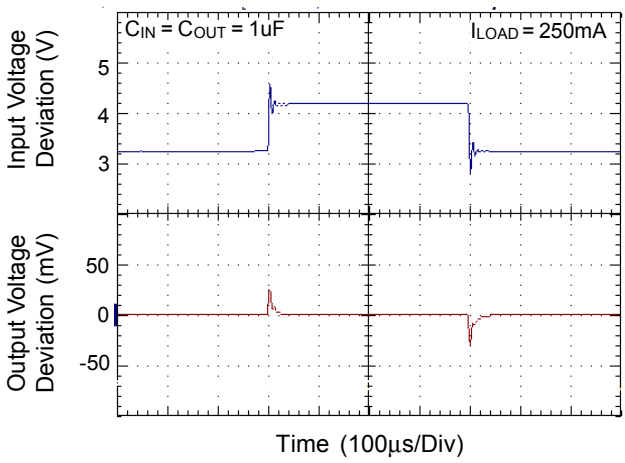
PSRR



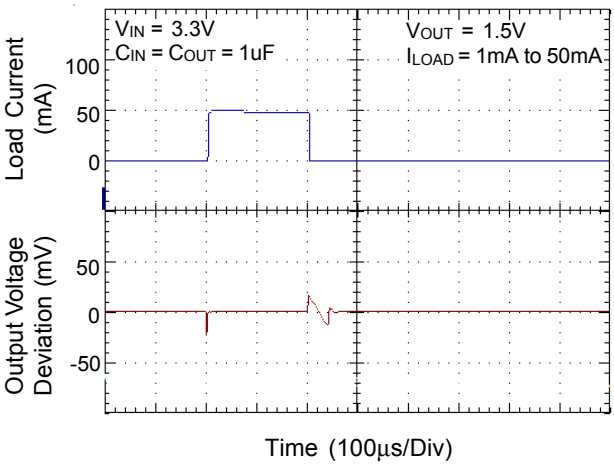
Line Transient Response



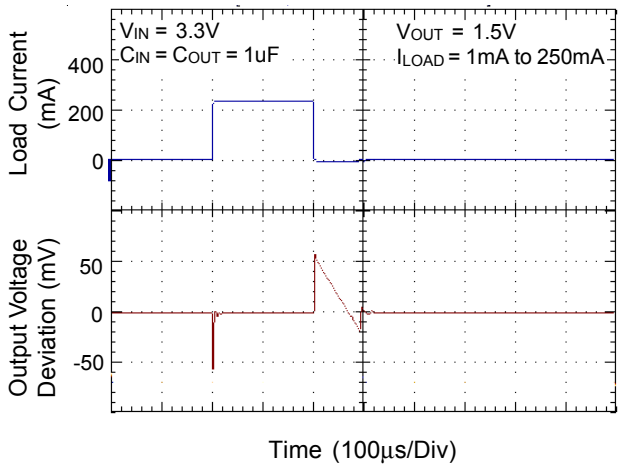
Line Transient Response



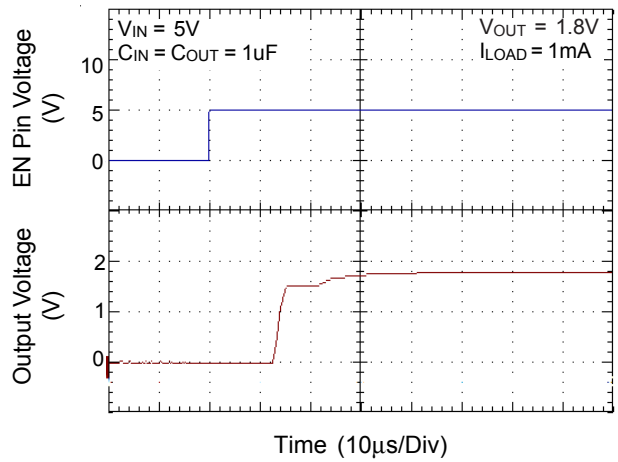
Load Transient Response



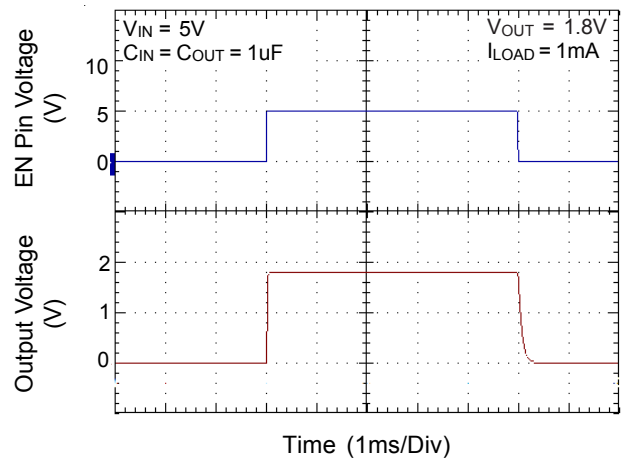
Load Transient Response

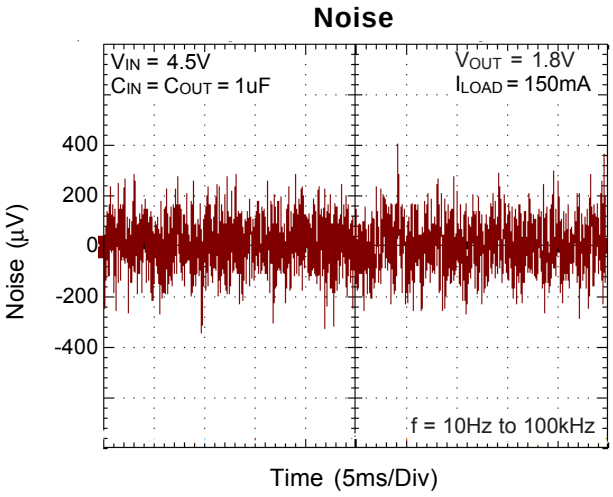


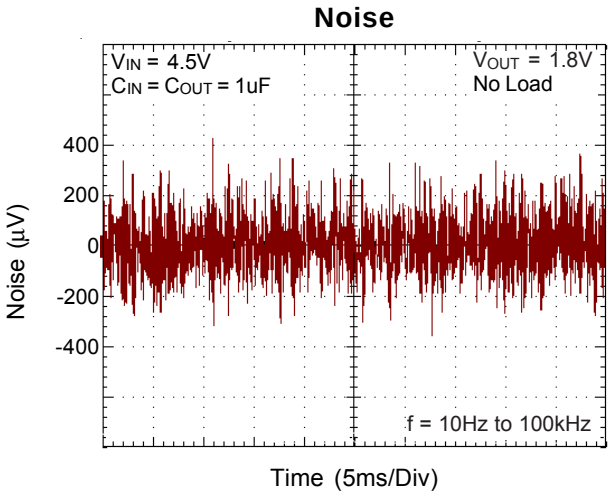
Start Up



EN Pin Shutdown Response




Noise
VIN = 4.5V
CIN = COUT = 1uF
VOUT = 1.8V
ILOAD = 150mA
400
200
0
-200
-400
Noise (μV)
f = 10Hz to 100kHz
Time (5ms/Div)


Noise
VIN = 4.5V
CIN = COUT = 1uF
VOUT = 1.8V
No Load
400
200
0
-200
-400
Noise (μV)
f = 10Hz to 100kHz
Time (5ms/Div)

Applications Information

Like any low-dropout regulator, the external capacitors used with the RT9198T must be carefully selected for regulator stability and performance. Using a capacitor whose value is > 1μF on the RT9198T input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response.

The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The RT9198T is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least 1μF with ESR is > 20mΩ on the RT9198T output ensures stability. The RT9198T still works well with output capacitor of other types due to the wide stable ESR range. Figure 1. shows the curves of allowable ESR range as a function of load current for various output capacitor values. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the V_{OUT} pin of the RT9198T and returned to a clean analog ground.

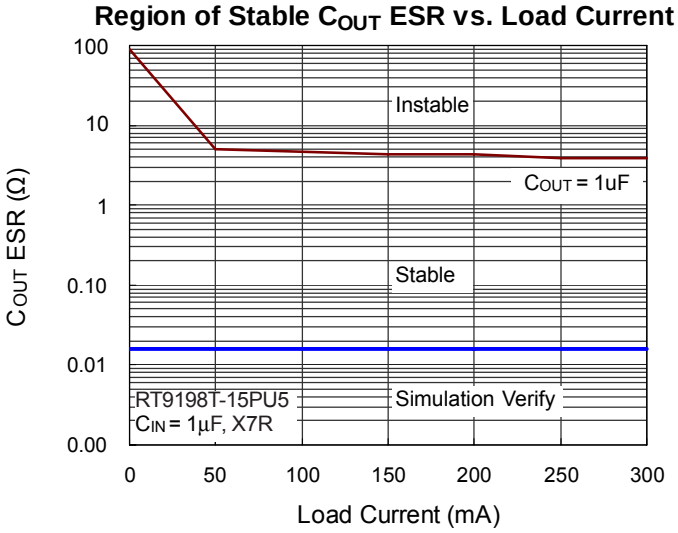


Figure 1

Enable Function

The RT9198T features an LDO regulator enable/disable function. To assure the LDO regulator will switch on, the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shutdown mode when the voltage on the EN pin falls below 0.4 volts. For to protecting the system, the RT9198T have a quick-discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Thermal Considerations

Thermal protection limits power dissipation in RT9198T. When the operation junction temperature exceeds 165°C, the OTP circuit starts the thermal shutdown function and turns the pass element off. The pass element turn on again after the junction temperature cools by 30°C.

RT9198T lowers its OTP trip level from 165°C to 110°C when output short circuit occurs (V_{OUT} < 0.4V) as shown in Figure 2. This limits IC case temperature under 100°C and provides maximum safety to end users when output short circuit occurs.

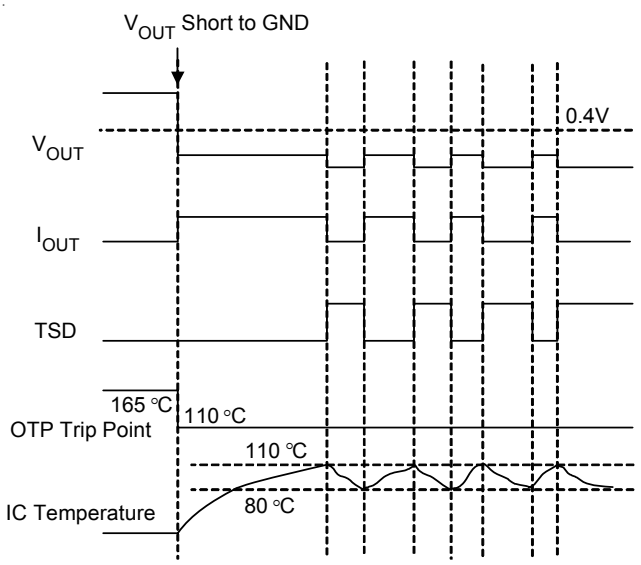


Figure 2. Short Circuit Thermal Folded Back Protection when Output Short Circuit Occurs

For continuous operation, do not exceed absolute maximum operation junction temperature 125°C. The power dissipation definition in device is :

$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_Q$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula :

$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$

Where $T_{J(MAX)}$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

For recommended operating conditions specification of RT9198T, where $T_{J(MAX)}$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA} is layout dependent) for SC-70 package is 333°C/W, 250°C/W is for SOT-23-3 and SOT-23-5 package on standard JEDEC 51-3 thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by following formula :

$P_{D(MAX)}$ = (125°C–25°C)/250 = 400 mW (SOT-23-3/ SOT-23-5)

$P_{D(MAX)}$ = (125°C–25°C)/333 = 300 mW (SC-70-5)

The maximum power dissipation depends on operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA}. For RT9198T packages, the Figure 3. of derating curves allows the designer to see the effect of rising ambient temperature on the maximum power allowed.

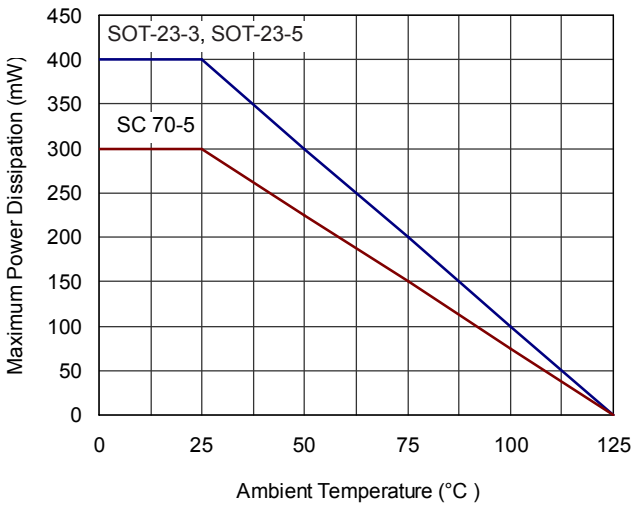
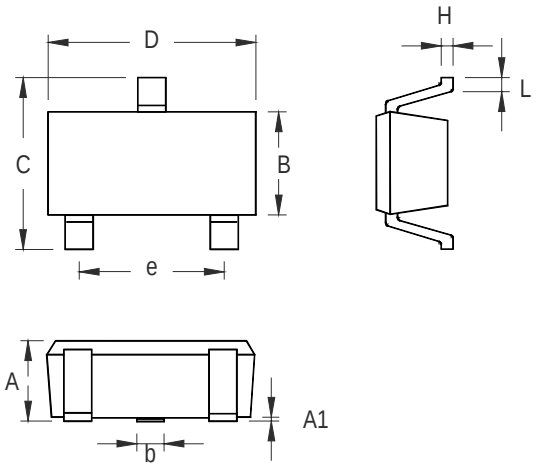


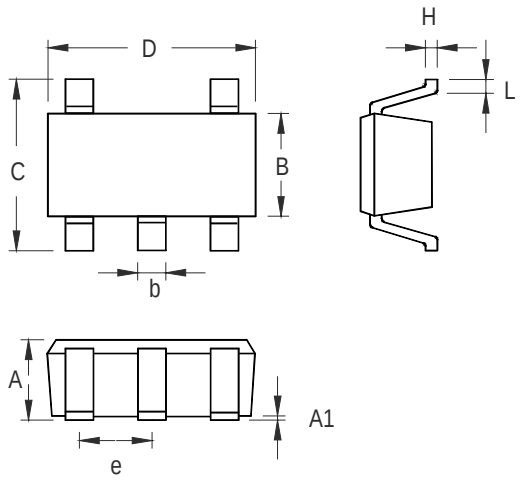
Figure 3. Derating Curve for Packages

Outline Dimension



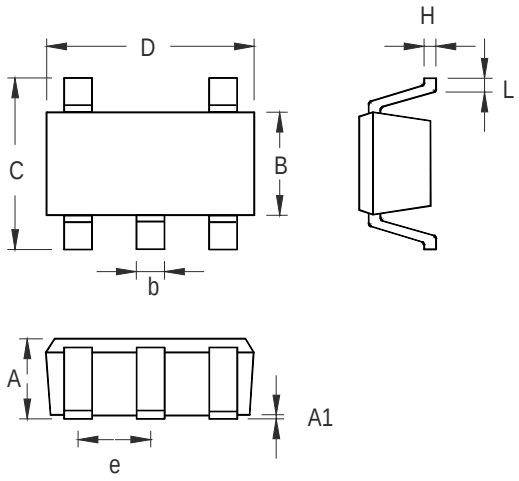
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.508	0.014	0.020
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	1.803	2.007	0.071	0.079
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT-23-3 Surface Mount Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	0.838	1.041	0.033	0.041
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT-23-5 Surface Mount Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.100	0.031	0.044
A1	0.000	0.100	0.000	0.004
B	1.150	1.350	0.045	0.054
b	0.150	0.400	0.006	0.016
C	1.800	2.450	0.071	0.096
D	1.800	2.250	0.071	0.089
e	0.650		0.026	
H	0.080	0.260	0.003	0.010
L	0.210	0.460	0.008	0.018

SC-70-5 Surface Mount Package

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